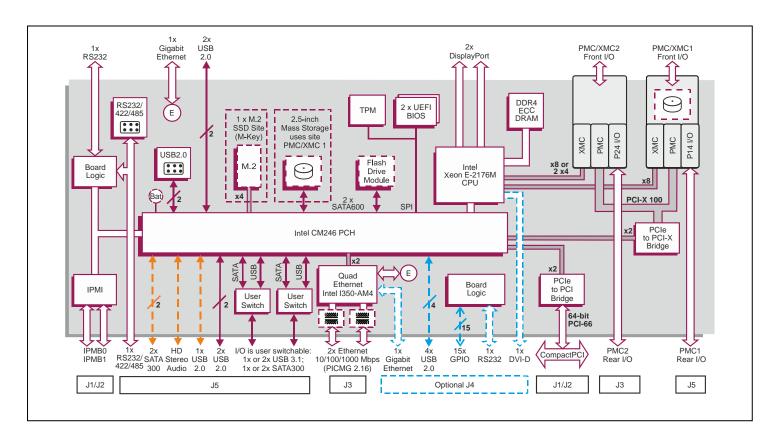
6U CompactPCI® Processor Board

Key Features

PP B7x/msd is a single slot air-cooled CompactPCl® board, allowing customers to easily migrate to the latest generation of Intel® processors for longer system life-cycles. PP B7x/msd processor board is based on a 6-core Intel® Xeon® processor E-2176M (formerly known as Coffee Lake-H).

- High performance 6-core processor
- Up to 32 Gbytes of memory
- Two XMC/PMC module slots for local I/O expansion
- Local solid-state storage options







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Specification

6U CompactPCI Processor Board

- air-cooled 6U CompactPCI® computing board utilizing an Intel® Xeon® processor based on Coffee Lake-H
- optional Rear Transition Module (RTM)

Central Processor

- 6-core Intel® Xeon® processor E-2176M:
 - → 12 Mbytes Smart Cache, 2.7 GHz
 - → Intel® UHD Graphics 630
- range of performance/power factory build options
- utilizes the Intel® CM246 Platform Controller Hub

- 16 or 32 Gbytes soldered DDR4 ECC DRAM:
 - → single bit error correction
 - → dual channel architecture
- accessible from processor and CompactPCI® bus

Mass Storage Interfaces

- up to four SATA interfaces accessed via J5:
 - → 2 x SATA300 interfaces (build option 1)
 - → 0, 1 or 2 x SATA300 interfaces user selectable, as alternatives to USB 3.1 (Gen 1) ports
- 2 x SATA600 interfaces for optional on-board:
 - → SATA Flash Drive Module
 - → 2.5-inch SATA drive (disables PMC/XMC Site 1)
- 1 x M.2 SSD site on-board supporting:
 - → Type 2242, 2260 and 2280 device
 - → x4 PCIe interface (M-key)
 - NVM Express® (NVMe™) logical device interface
 - → resides within PMC/XMC Site 1 and 2 areas

Gigabit Ethernet Interfaces

- up to four 1 Gigabit Ethernet interfaces
- 1 x front panel interface via an RJ45 connector
- 2 x rear interfaces via J3:
 - → support for PICMG® 2.16 R1.0 Packet Switching Backplane (build option) or via an optional RTM
- 1 x rear interface via optional J4
- implemented by an Intel® I350-AM4 controller

Dual PMC/XMC Interfaces

- dual PMC/XMC interfaces:
 - → front panel I/O
- PMC sites support:
 - → PMC P14 rear I/O via J5
 - → PMC P24 rear I/O via J3
 - → 32/64-bit, 33/66MHz PCI bus
 - → 64-bit, 100MHz PCI-X[™] bus
 - → 5V and 3.3V signaling
- XMC sites support:
 - → both support x8 PCI Express® (PCIe®)
 - → XMC site 2 can also support 2 x4 PCI Express
 - → PCle Gen 1, Gen 2 (and optionally Gen 3)
 - → XMC VPWR +5V
- XMC connector type (build option) determines the maximum PCIe operational speed:
 - → up to Gen 2, VITA 42 XMC (color black)
 - → up to Gen 3, VITA 61 XMC 2.0 (color white)

Stereo Audio

- Intel® High Definition Digital Audio (build option 1)
 - → optional CoDec on optional RTM

Serial Interfaces

- up to 3 x serial interfaces:
 - → 1 x Tx/Rx RS232 accessed via a front panel 60-way high-density connector
 - → 1 x RS232/422/485 via on-board header or J5
 - → 1 x RS232 via optional J4
- J5 (or on-board header) and J4 RS232 interfaces support Tx, Rx, RI, CTS, RTS, DSR, DTR and DCD
- J5 (or on-board header) RS422/485 interfaces support Tx and Rx
- 16550 compatible UARTs

Graphics Interfaces

- up to three independent graphics interfaces
- 2 x DisplayPort® v1.2 graphics interfaces via a front panel 60-way high-density connector:
 - → up to 1920 x 1200 @ 60Hz
 - → resolution is dependent on the device driver
- 1 x DVI-D graphics interface via optional J4:
 - → up to 1920 x 1200 @ 16M colors
- support for Microsoft® DirectX 12, OpenGL 4.5 under Windows® and Linux® and OpenCL 2.1

Other Peripheral Interfaces

- PC Real Time Clock
- watchdog timer; 32-bit Long Duration Timer with processor interrupt ability; chipset timer
- voltages monitor; CPU temperature and board temperature monitors; all accessible via IPMI
- 2 x USB 2.0 ports accessed via a front panel 60-way high-density connector
- 2 x USB 2.0 ports accessed via on-board header
- up to nine USB ports accessed via rear panel I/O:
 - → 4 x USB 2.0 ports via optional J4
 - → 2 or 3 x USB 2.0 ports (build option 1) via J5
 - → 0. 1 or 2 x USB 3.1 (Gen 1) ports via J5 user selectable, as alternatives to SATA300 ports
- 15 x GPIO signals accessed via optional J4
- independent legacy speaker output via J3

- PICMG 2.9 R1.0 (System Management):
 - → implements IPMB0/IPMB1 interfaces
- **Baseboard Management Controller**
- supports 8 Kbytes of non-volatile memory

Software Support

support for Linux[®], Windows[®] and VxWorks[®]

Firmware Support

- UEFI boot firmware (BIOS):
 - → based on EDK II
 - → implements Secure Boot
- implements Intel® Boot Guard
- optional Fast Boot solution using the Intel® Firmware Support Package (FSP)
- LAN boot firmware included

SPI Flash EPROM

- 32 Mbytes of BIOS Flash EPROM, dual devices:
 - → main/backup device enabled via switch

Board Security Packages

- Trusted Platform Module (TPM 2.0)
- option for Sanitization Utility Software Package
- option for proprietary board-level security features

CompactPCI Interface

- compliant with PICMG 2.0 R3.0: 3.3V or 5V signaling levels (universal signaling support)
- 33/66 MHz, 32/64-bit interface accessed via J1/J2 connectors
- PICMG 2.1 R2.0 Hot Swap compliant
- operates as System Slot controller or in a Peripheral slot (auto-selected on insertion to backplane)
- option to disable CompactPCI interface (Satellite
 - → receives power from CompactPCI bus
 - → board can be hot swapped

Safety

 PCB (PWB) manufactured with a flammability rating of UL94V-0

Electrical Specification (Estimated)

- typical current figures (based on 6-core CPU (45W) 16 GBytes DRAM):
 - → +5V @ 8.0A
 - → +3.3V @ 13.0A
 - → +12V and -12V, both @ 0.0A
- +12V and -12V are not required, but are routed to PMC/XMC sites

Environmental Specification

- operating temperature:
 - → 0°C to +55°C (N-Series)
- extended operating temperatures (based upon selected processor performance/power option):
 - → -25°C to +70°C (E-Series)
 - → -40°C to +70°C (K-Series)
 - → -40°C to +85°C (K-Series)
- non-operating temperature: -40°C to +85°C
- 5% to 95% Relative Humidity, non condensing:
 - → K-Series includes humidity sealant

Mechanical Specification

- 6U form-factor:
- 9.2 inches x 6.3 inches (233mm x 160mm)
- single slot: 0.8 inches (20.3mm)
- connectors: IEC-1076-4-101 for J1-J5:
 - → J4 is a factory build option

operating vibration:

operating shock: 20g, 11ms, 1/2 sine

5Hz-2000Hz at 2g, 0.38mm peak displacement

Legacy Board Compatibility PP B7x/msd rear plug compatibility with the popular PP B1x/msd family